



Advanced Stem Cell Technology and Regenerative Medicine

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Message from the Guest Editors

Dear Colleagues,

The development of stem cell technology and regenerative medicine is advancing rapidly. This is due to the interests of researchers and the demands of various stakeholders in this field.

The main aim of stem cell technology and regenerative medicine is to facilitate the repair and growth of damaged tissues or organs. This has led to the development of various treatment methods, the discovery of potential therapies as well as products based on stem cells, and their commercialization potential.

This Special Issue will be dedicated to new and advanced perspectives in stem cell technology and regenerative medicine. The focus will not only be on advanced methods and technologies but also on other related updates, including verifications in animal models and clinical trials.

Dr. Wan Kamarul Zaman Wan Safwani

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Guest Editors





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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal *Applied Sciences* has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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